5084616-8 ACTIVE

Free Height

TE Internal #: 5084616-8

PCB Mount Receptacle, Vertical, Board-to-Board, 160 Position, .8 mm [.031 in] Centerline, Gold, Surface Mount, Signal, Natural, Free

Height

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > Free Height Receptacle Conn: Board-Board, Vertical, 160, 0.8mm



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 160

Centerline (Pitch): .8 mm [.031 in]

All Free Height Receptacle Conn: Board-Board, Vertical, 160, 0.8mm (17)

Features

Electrical Characteristics

Operating Voltage	100 VAC
Insulation Resistance	2 ΜΩ
Dielectric Withstanding Voltage (Max)	500 VAC

Dimensions

Stack Height	14 mm, 15 mm, 13 mm, 16 mm[.63 in][.591 in][.551 in][.512 in]
Connector Height	13 mm[.512 in]

Packaging Features

	.5 in
Packaging Quantity	200
Packaging Method	Tape & Reel

Usage Conditions



Housing Temperature Rating	High
Operating Temperature Range	-40 - 125 °C[-40 - 257 °F]
Body Features	
Assembly Process Feature Material	Steel
Primary Product Color	Natural
Operation/Application	
Assembly Process Feature	Pick and Place Cover
Circuit Application	Signal
Mechanical Attachment	
Mounting Alignment Feature Length	.5 mm[.02 in]
Mating Alignment Type	Polarization
PCB Mount Alignment Type	Positioning Bosses
PCB Mount Retention	Without
PCB Mount Alignment	With
Connector Mounting Type	Board Mount
Mating Alignment	With
Termination Features	
Rectangular Termination Post & Tail Width	.3 mm[.012 in]
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Termination Method to PCB	Surface Mount
Contact Features	
PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Thickness	.2 μm[8 μin]
Mating Tab Width	.4 mm[.016 in]
PCB Contact Termination Area Plating Material Thickness	2 μm[78.74 μin]
Contact Shape & Form	Square
Contact Layout	Inline
Contact Base Material	Copper Alloy
Mating Tab Thickness	.2 mm[.008 in]
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material	Gold
Contact Type	Socket



Contact Current Rating (M	Max)	.5 A
Contact Current Nating (i	VIAA)	.5 /~

Housing Features

Mating Entry Location	Тор
Housing Material	Matte
Centerline (Pitch)	.8 mm[.031 in]

Configuration Features

Board-to-Board Configuration	Parallel
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	160

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Industry Standards

Other

EU RoHS Compliance	Compliant
EU ELV Compliance	Compliant

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free



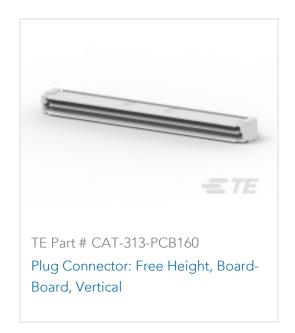
Solder Process Capability

Reflow solder capable to 260°C

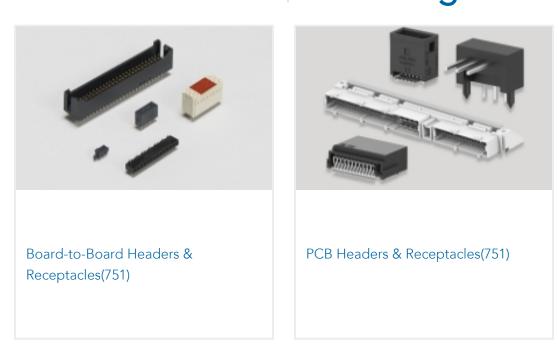
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Free Height



Customers Also Bought













TE Part #2170330-1 HMZD+,4PAIRS,10COLS,VERTICAL, ASSEMBLY



TE Part #5-2301994-6

RJ45 JACK INT.MAG. 1GB 1X1

Z9POS, MIXED,REC HSG,ASSY, SEALED



TE Part #2-2208157-1 4POS, MIXED REC HSG, ASSY, SEALED, COD B



TE Part #350833-4 04P UMNL HDR ASSY PC 94VO LF



Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5084616-8_R.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5084616-8_R.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5084616-8_R.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

Fine Pitch Stacking Connectors - 0.8mm Free Height (FH) Connectors

English

Product Specifications

75 Ohm Mini-SMB Series Coaxial Connector

English

Product Specification

English

Product Specification

English